

FQPF5P10-VB Datasheet

P-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 100	0.220 at V _{GS} = - 10 V	- 12	11.7		
- 100	0.230 at V _{GS} = - 4.5 V	- 10	11.7		

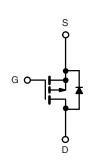
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
 - Trench Power MOSFET
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_{C} = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 100	V		
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	L	- 12	А	
	T _C = 70 °C		- 8.6		
Pulsed Drain Current		I _{DM}	- 36	A	
Avalanche Current		I _{AS}	- 18		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	16.2	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	P	38.1 ^b	w	
	T _A = 25 °C ^c	– P _D –	2.5		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3.9	- °C/W	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).





Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 100			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1		- 2.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
Zero Gate Voltage Drain Current		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
	I _{DSS}	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA	
		V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 150 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 15			А	
	D	V _{GS} = - 10 V, I _D = - 3.6 A		0.220		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.230			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S	
Dynamic ^b		· · · · ·					
Input Capacitance	C _{iss}			1055		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65			
Reverse Transfer Capacitance	C _{rss}			41			
Total Gate Charge ^c	Qg	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23.2	34.8	nC	
		V _{DS} = - 50 V, V _{GS} = - 4.5 V, I _D = - 3.6 A		11.7	17.6		
Gate-Source Charge ^c	Q _{gs}			3.5			
Gate-Drain Charge ^c	Q _{gd}			4.8			
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	V_{DD} = - 50 V, R_L = 17.2 Ω		12	18	20	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ - 2.9 A, V_GEN = - 10 V, R_g = 1 Ω		33	50	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings and	nd Character	istics T _C = 25 °C ^b					
Continuous Current	۱ _S				- 8.8	^	
Pulsed Current	I _{SM}				- 15	A	
Forward Voltage ^a	V _{SD}	$I_{F} = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	А	
Reverse Recovery Charge	Q _{rr}	1 1		98	147	nC	

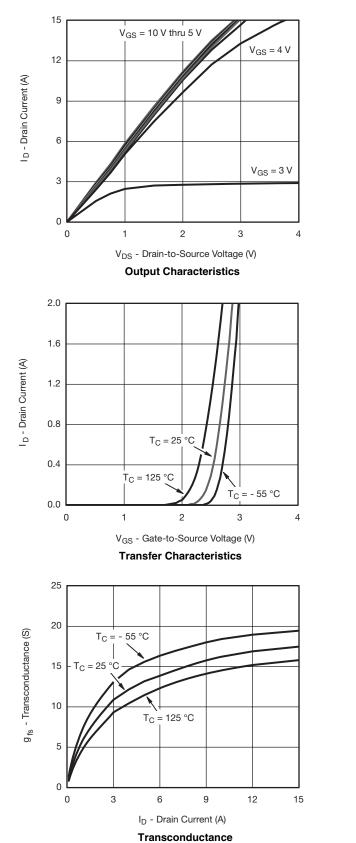
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

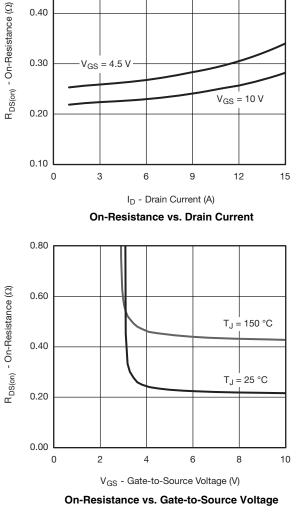
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

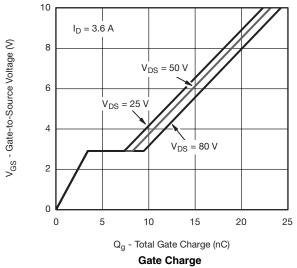




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

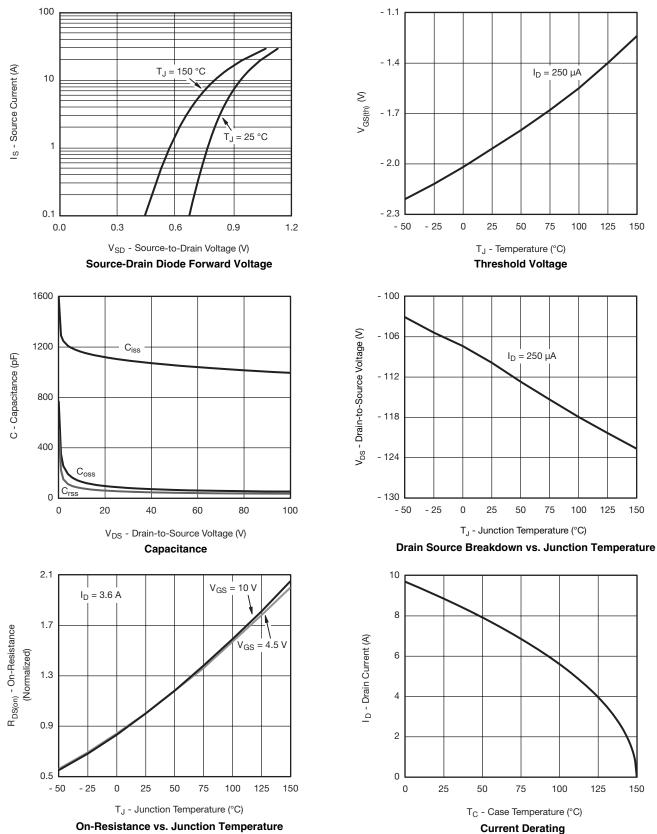


0.50





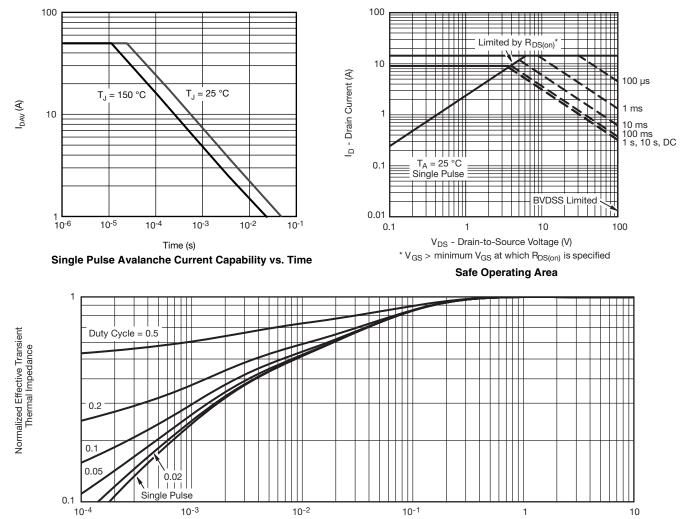
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服务热线:400-655-8788



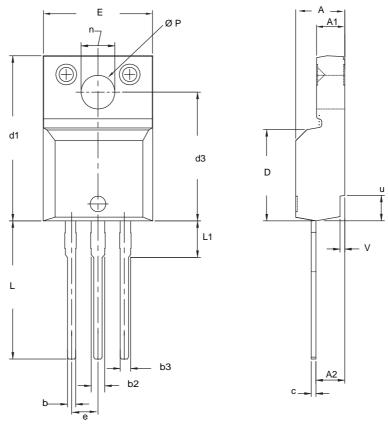
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK



MIN. 4.570 2.570 2.510 0.622	MAX. 4.830 2.830 2.850	MIN. 0.180 0.101	MAX. 0.190 0.111
2.570 2.510	2.830	0.101	
2.510			0.111
	2.850		5.111
0.622		0.099	0.112
	0.890	0.024	0.035
1.229	1.400	0.048	0.055
1.229	1.400	0.048	0.055
0.440	0.629	0.017	0.025
8.650	9.800	0.341	0.386
15.88	16.120	0.622	0.635
12.300	12.920	0.484	0.509
10.360	10.630	0.408	0.419
2.54 BSC		0.100 BSC	
13.200	13.730	0.520	0.541
3.100	3.500	0.122	0.138
6.050	6.150	0.238	0.242
3.050	3.450	0.120	0.136
2.400	2.500	0.094	0.098
0.400	0.500	0.016	0.020
	0.440 8.650 15.88 12.300 10.360 2.54 13.200 3.100 6.050 3.050 2.400	0.440 0.629 8.650 9.800 15.88 16.120 12.300 12.920 10.360 10.630 2.54 BSC 13.200 13.730 3.100 3.500 6.050 6.150 3.050 3.450 2.400 2.500 0.400 0.500	0.440 0.629 0.017 8.650 9.800 0.341 15.88 16.120 0.622 12.300 12.920 0.484 10.360 10.630 0.408 2.54 BSC 0.100 13.200 13.730 0.520 3.100 3.500 0.122 6.050 6.150 0.238 3.050 3.450 0.120 2.400 2.500 0.094 0.400 0.500 0.016

Notes

Notes 1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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